

# **MX-4**

# **Thermal Compound**

### **Main Features**

- Easy to apply
- · Optimal thermal conductivity
- · Low thermal resistance
- Electrically non-conductive
- · Non-capacitive
- Non-curing
- · Non-corrosive
- · Non-bleeding





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# **MX-4**

## **Thermal Compound**

The MX-4's consistency is engineered for simplicity of application, superior thermal conductivity and high durability. With its new

Formula, the MX-4 guarantees exceptional heat dissipation from the components and supports the stability needed to push your system to its limit.

The **MX-4** is metal-free and non-electrical conductive which eliminates any risks of causing short circuit, adding more protection to the CPU and VGA cards.

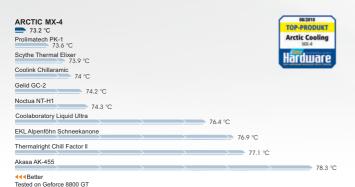
# Section 1

### Application

CPU, GPU, power semiconductor components

Data source: PC Games Hardware, Germany, August 2010, page no. 20-21

Specifications	
Thermal Conductivity	8.5 W/mK
Viscosity	870 poise
Density	2.5 g/cm <sup>3</sup>
Net weight	4 g / 20 g





4g

20g

